

General Description

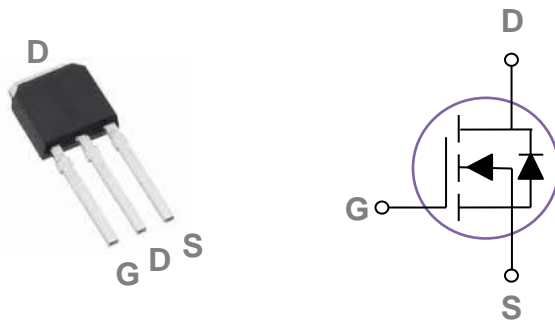
These N-Channel enhancement mode power field effect transistors are using Super Junction technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply

BVDSS	RDSON	ID
650V	360mΩ	11A

Features

- 650V, 11A, $R_{DS(ON)} = 360m\Omega @ V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

TO251 Pin Configuration



Applications

- PFC Power Supply Stages
- Motor Control
- DC-DC Converters
- Adapter

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	650	V
V _{GS}	Gate-Source Voltage	±30	V
I _D	Drain Current – Continuous (T _C =25°C)	11	A
	Drain Current – Continuous (T _C =100°C)	6.9	A
I _{DM}	Drain Current – Pulsed ¹	44	A
EAS	Single Pulse Avalanche Energy	210	mJ
P _D	Power Dissipation (T _C =25°C)	75	W
	Power Dissipation – Derate above 25°C	0.6	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62.5	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	1.65	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =1mA	650	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =650V , V _{GS} =0V , T _J =25°C	---	---	1	uA
		V _{DS} =520V , V _{GS} =0V , T _J =125°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±30V , V _{DS} =0V	---	---	±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =4A	---	320	360	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	2	3	4	V

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{2,3}	V _{DS} =480V , V _{GS} =10V , I _D =6A	---	21	32	nC
Q _{gs}	Gate-Source Charge ^{2,3}		---	4	6	
Q _{gd}	Gate-Drain Charge ^{2,3}		---	7	11	
T _{d(on)}	Turn-On Delay Time ^{2,3}	V _{DD} =480V , V _{GS} =10V , R _G =25Ω I _D =6A	---	18	27	ns
T _r	Rise Time ^{2,3}		---	41	62	
T _{d(off)}	Turn-Off Delay Time ^{2,3}		---	110	165	
T _f	Fall Time ^{2,3}		---	39	59	
C _{iss}	Input Capacitance	V _{DS} =100V , V _{GS} =0V , F=1MHz	---	670	1005	pF
C _{oss}	Output Capacitance		---	30	45	
C _{rss}	Reverse Transfer Capacitance		---	1.5	5.3	
R _g	Gate resistance	V _{GS} =0V , V _{DS} =0V , F=1MHz	---	20	---	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V , Force Current	---	---	11	A
I _{SM}	Pulsed Source Current		---	---	22	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =6A , T _J =25°C	---	---	1.4	V
t _{rr}	Reverse Recovery Time ²	V _R =400V , I _S =10A , dI/dt=100A/μs , T _J =25°C	---	320	---	ns
Q _{rr}	Reverse Recovery Charge ²		---	3.8	---	uC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

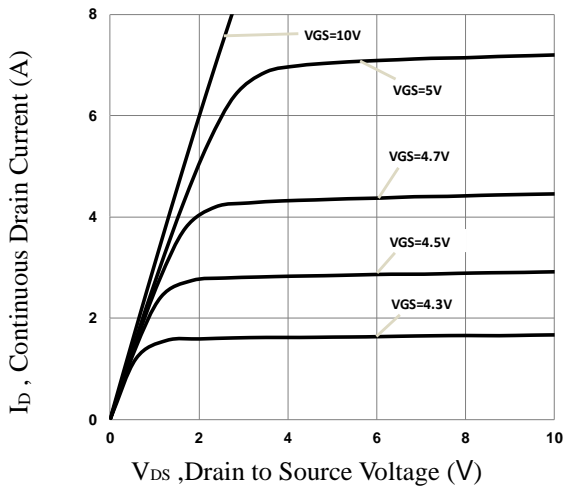


Fig.1 Typical Output Characteristics

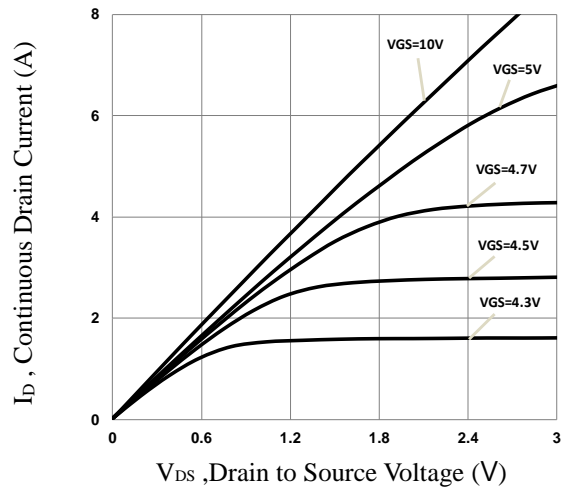


Fig.2 Typical Output Characteristics

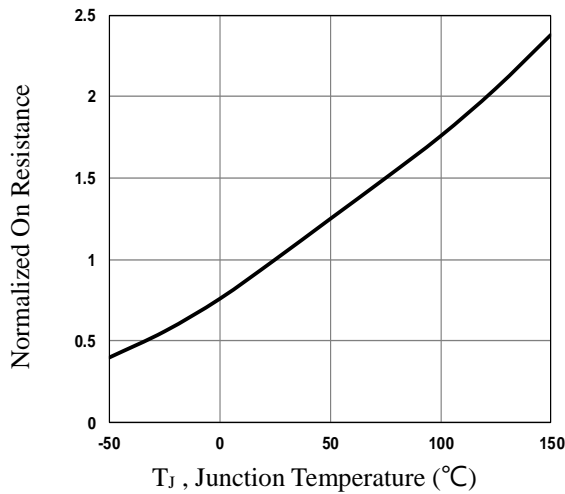


Fig.3 Normalized $R_{DS(on)}$ vs. T_J

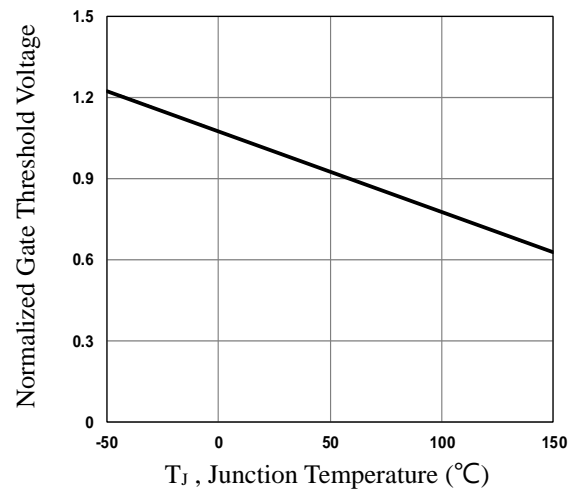


Fig.4 Normalized V_{th} vs. T_J

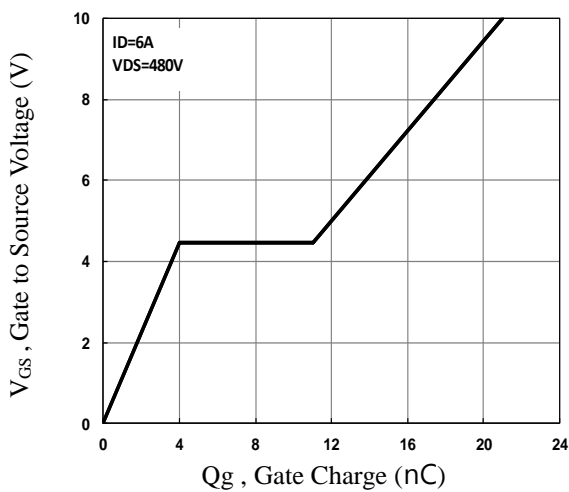


Fig.5 Gate Charge Characteristics

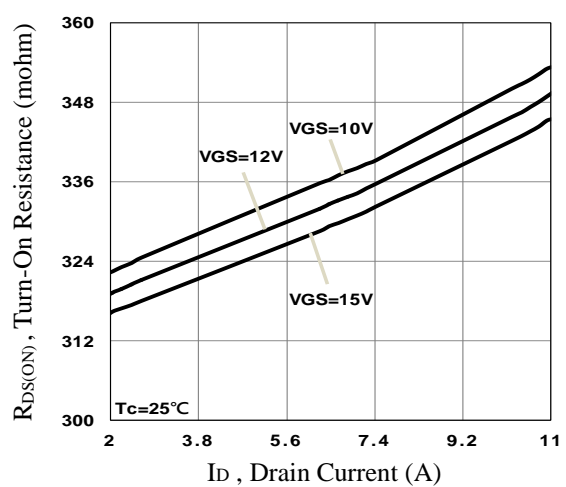


Fig.6 Turn-On Resistance vs. I_D

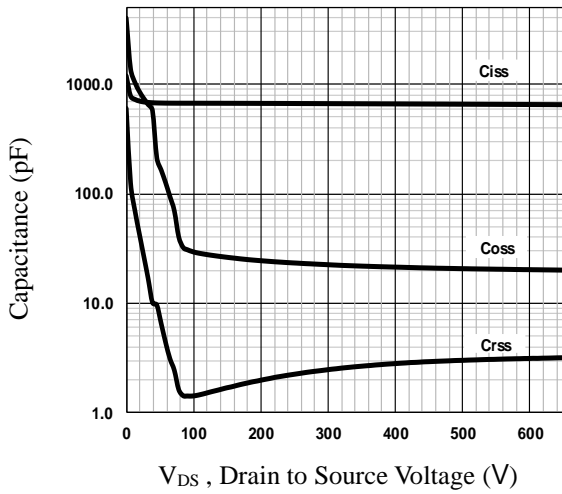


Fig.7 Capacitance Characteristics

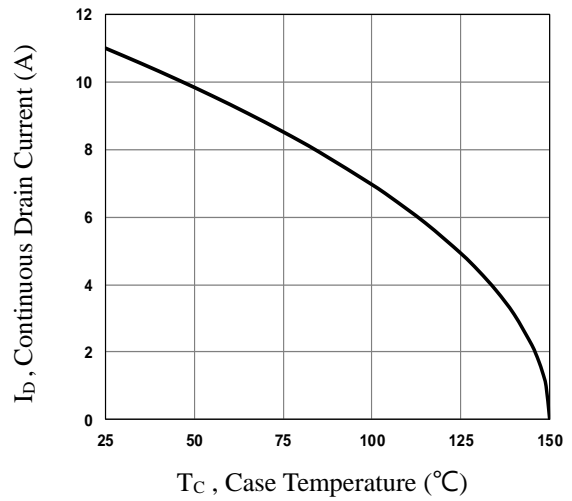


Fig.8 Continuous Drain Current vs. T_c

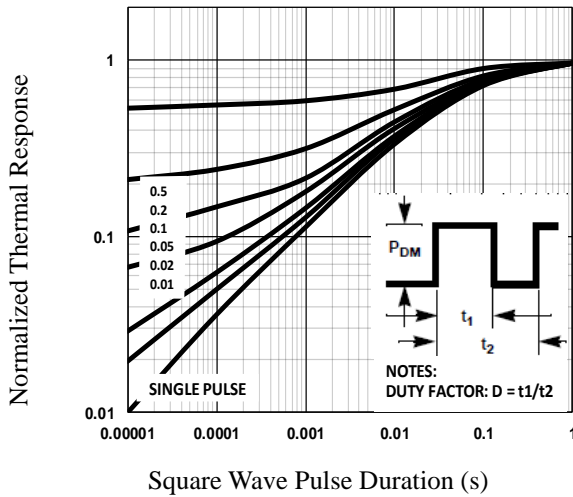


Fig.9 Normalized Transient Impedance

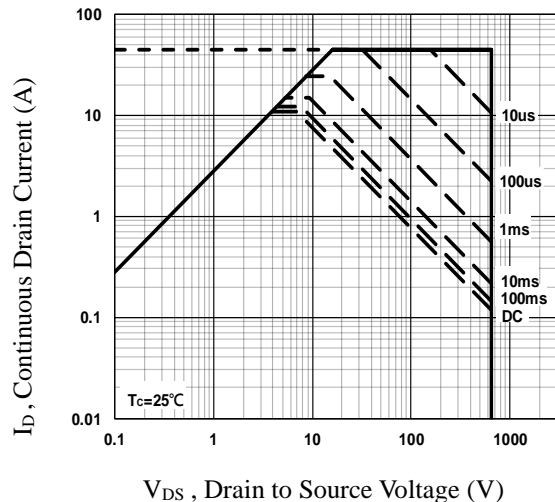


Fig.10 Maximum Safe Operation Area

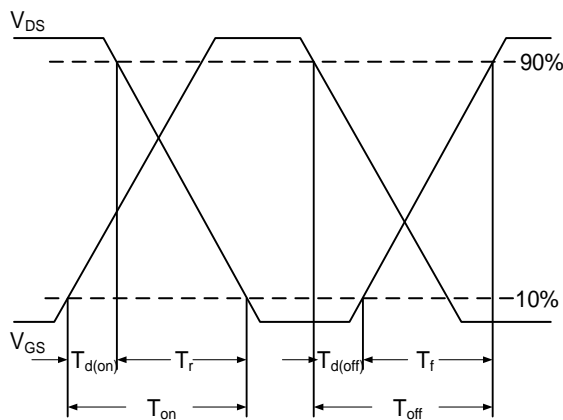


Fig.11 Switching Time Waveform

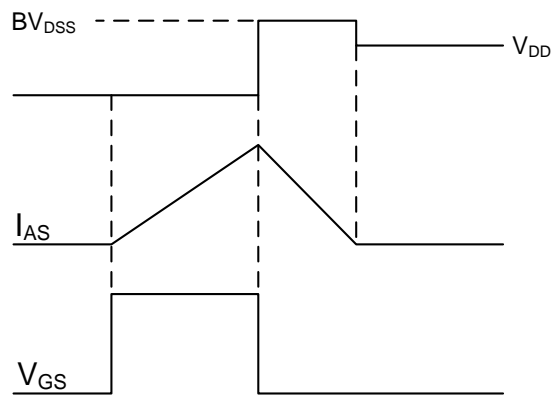
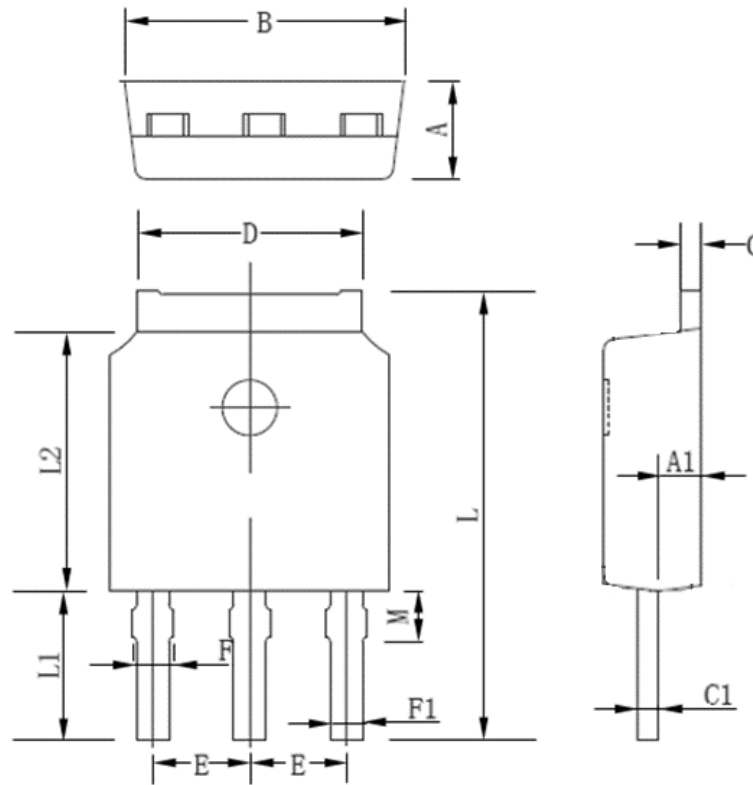


Fig.12 EAS Waveform

TO251 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.500	2.100	0.098	0.083
A1	1.250	0.900	0.049	0.035
B	6.800	6.400	0.268	0.252
C	0.580	0.420	0.023	0.017
C1	0.580	0.420	0.023	0.017
D	5.530	5.000	0.218	0.197
E	2.400	2.000	0.094	0.079
F	1.050	0.600	0.041	0.024
F1	0.900	0.500	0.035	0.020
L	12.400	9.600	0.488	0.378
L1	5.300	3.800	0.209	0.150
L2	6.400	5.700	0.252	0.224